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Part Number: [0459110037](#)
Status: **Active**
Description: 12.90mm (.508") Pitch EXTreme PowerEdge™, Mixed Power/Signal Card Edge Connector, Double Sided, 4 Segments (Signal, Signal, Power, Power Sequence), Through Hole Solder for 2.36mm (.093") or 3.18mm (.125") Thick PC Board

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)

[Product Specification PS-45719-001 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA	LR 19980
TUV	30482572.001
UL	E29179

General

Product Family	Edge Card Connectors
Series	45911
Component Type	Edgecard to PCB
Product Name	EXTreme PowerEdge™

Physical

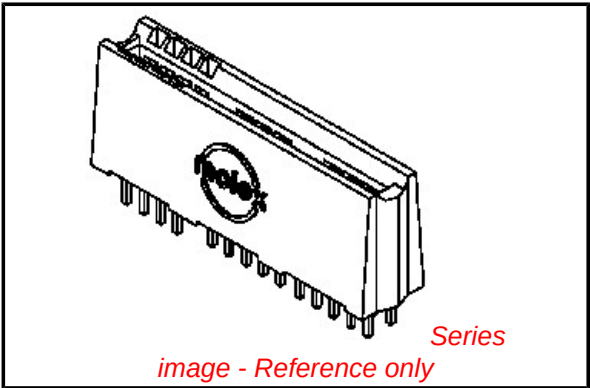
Circuits (Loaded)	20
Circuits (maximum)	20
Circuits Detail	8 Signal, 8 Signal, 2 Power, 2 Power
Color - Resin	Black
Durability (mating cycles max)	250
Entry Angle	Vertical (Top Entry)
Flammability	94V-0
Keying to Mating Part	N/A
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
PC Tail Length (in)	0.182 In
PC Tail Length (mm)	4.63 mm
PCB Thickness Recommended (in)	0.093 In, 0.125 In
PCB Thickness Recommended (mm)	2.40 mm, 3.20 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.508 In
Pitch - Mating Interface (mm)	12.90 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	150
Plating min: Termination (µm)	3.75
Temperature Range - Operating	-40°C to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	3A, 40A
Voltage - Maximum	250V

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	250



EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Contains SVHC: No
Halogen-Free
Status

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[45911Series](#)

Mates With
1.58mm (.062") double sided card edge

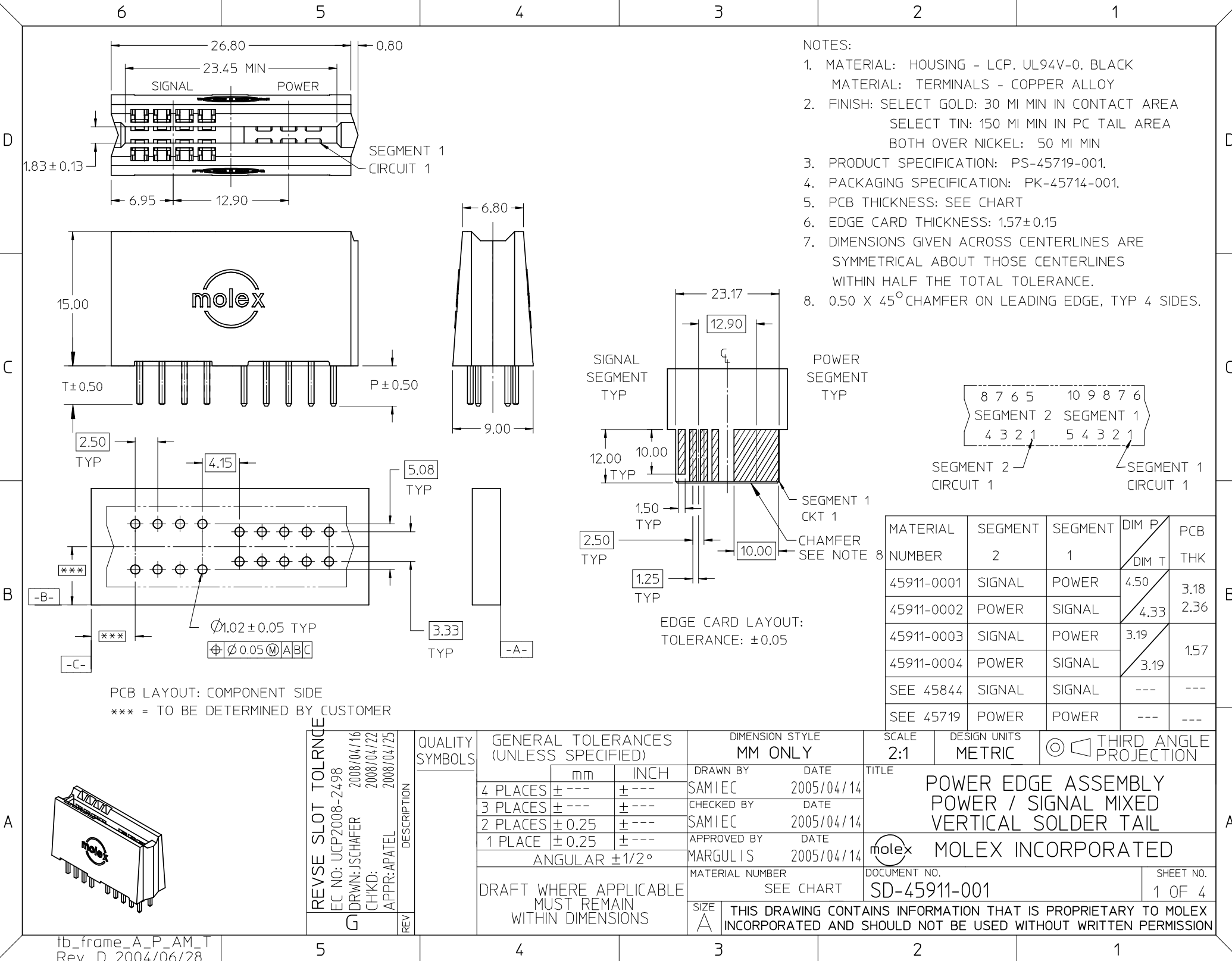
Material Info

Reference - Drawing Numbers

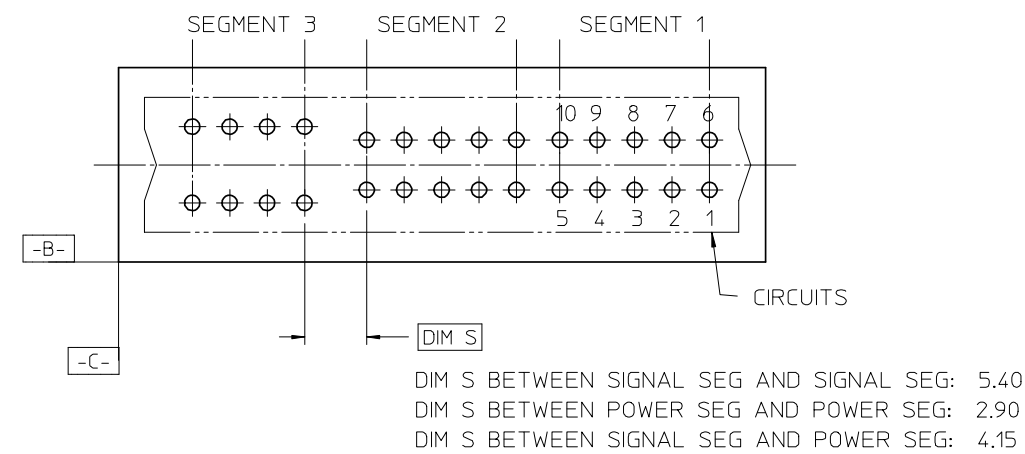
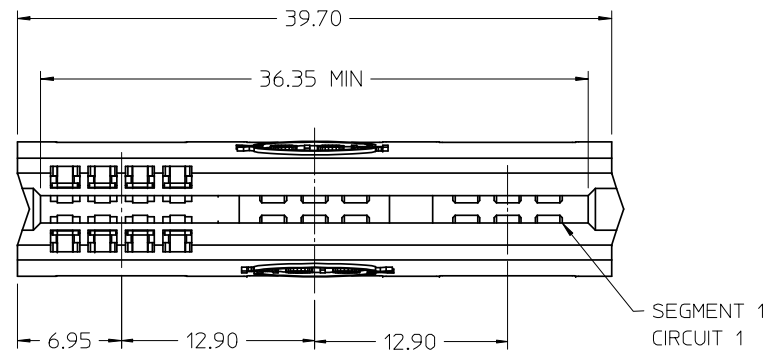
Product Specification	PS-45719-001
Sales Drawing	SD-45911-001

This document was generated on 04/09/2010

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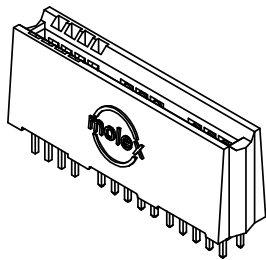


MATERIAL NUMBER: 45911-0007 SHOWN
SEE SHEET ONE FOR ALL OTHER NOTES AND DIMENSIONS

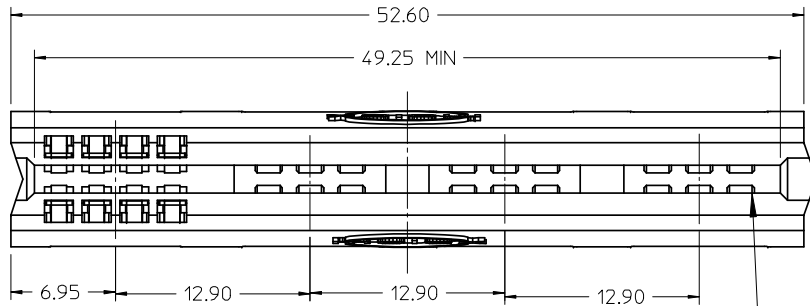


PCB LAYOUT: COMPONENT SIDE

MATERIAL NUMBER	SEGMENT 3	SEGMENT 2	SEGMENT 1	$\frac{DIM P}{DIM T}$	PCB THK
45911-0007	SIGNAL	POWER	POWER	$\frac{4.50}{4.33}$	3.18 2.36
45911-0008	POWER	SIGNAL	POWER		
45911-0009	SIGNAL	SIGNAL	POWER		
45911-0010	SIGNAL	POWER	SIGNAL		
45911-0011	POWER	SIGNAL	SIGNAL		
45911-0012	POWER	POWER	SIGNAL	$\frac{3.19}{3.19}$	1.57
45911-0013	SIGNAL	POWER	POWER		
45911-0014	POWER	SIGNAL	POWER		
45911-0015	SIGNAL	SIGNAL	POWER		
45911-0016	SIGNAL	POWER	SIGNAL		
45911-0017	POWER	SIGNAL	SIGNAL		
45911-0018	POWER	POWER	SIGNAL		

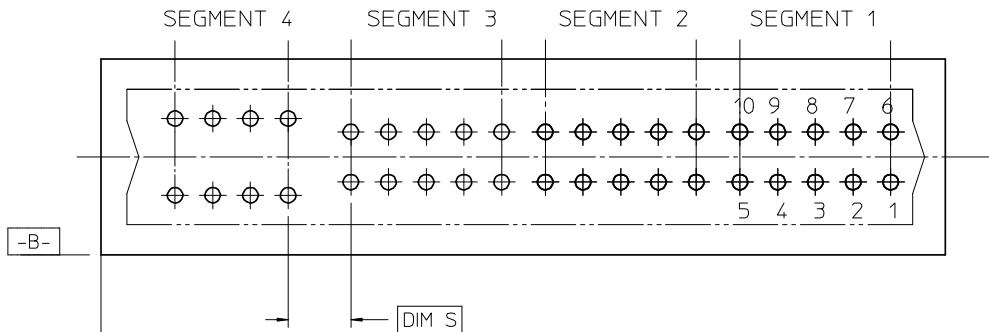


EC NO: UCP2008-2498		2008/04/16		QUALITY SYMBOLS	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
DRWN: JSCHAFFER		2008/04/22						MM ONLY		1:1	METRIC		
CHKD:	APPR: APATEL							DRAWN BY		DATE	TITLE	POWER EDGE ASSEMBLY POWER / SIGNAL MIXED VERTICAL SOLDER TAIL  MOLEX INCORPORATED	
		4 PLACES				± ---	± ---	SAMIEC	2005/04/14				
		3 PLACES				± ---	± ---	CHECKED BY	DATE				
		2 PLACES				± 0.25	± ---	SAMIEC	2005/04/14				
		1 PLACE				± 0.25	± ---	APPROVED BY	DATE				
		ANGULAR ±1/2°				MARGULIS	2005/04/14	MATERIAL NUMBER	DOCUMENT NO.	SHEET NO.			
				DRAFT WHERE APPLICABLE		SEE CHART		SD-45911-001	2 OF 4				
				MUST REMAIN WITHIN DIMENSIONS		SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
						A							



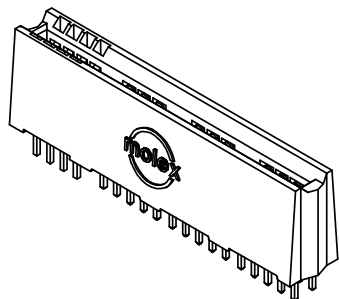
SEGMENT 1
CIRCUIT 1

SEE CHART ON SHEET 4
FOR MATERIAL NUMBERS



DIM S BETWEEN SIGNAL SEG AND SIGNAL SEG: 5.40
DIM S BETWEEN POWER SEG AND POWER SEG: 2.90
DIM S BETWEEN SIGNAL SEG AND POWER SEG: 4.15

PCB LAYOUT: COMPONENT SIDE



EC NO: UCP2008-2498 DRWN: JSCHAFER CHKD: APPR: APATEL		2008/04/16 2008/04/22 2008/04/25	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
						mm	INCH	DRAWN BY DATE		TITLE			
G		REV			4 PLACES	± ---	± ---	SAMIEC 2005/04/14		POWER EDGE ASSEMBLY POWER / SIGNAL MIXED VERTICAL SOLDER TAIL			
					3 PLACES	± ---	± ---	CHECKED BY DATE					
					2 PLACES	± 0.25	± ---	SAMIEC 2005/04/14					
					1 PLACE	± 0.25	± ---	APPROVED BY DATE		MOLEX INCORPORATED			
					ANGULAR ±1/2°			MARGULIS 2005/04/14					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NUMBER		DOCUMENT NO.				SHEET NO.					
		SEE CHART ON SHEET 4		SD-45911-001				3					
G		REV			SIZE A		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

